





## **GENERAL PURPOSE SILICON RECTIFIER**

1N4007S-26



A-405 Axial Leaded Plastic Package RoHS compliant

A-405

#### **FEATURE:**

- 1. The Plastic Package carries Underwriter Laboratory Flammability Classification 94V-0.
- 2. Low Reverse Leakage
- 3. High Forward Surge Current Capability
- 4. High Temperature Soldering Guaranteed : 250°C/10 seconds, 0.375"(9.5mm) Lead Length, 5lbs (2.3Kg) tension
- 5. Colour Band Denotes Cathode end

## ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	VALUE	UNIT
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	1000	V
Maximum RMS Voltage	$V_{RMS}$	700	V
Maximum DC Blocking Voltage	$V_{DC}$	1000	V
Maximum Average Forward Rectified Current 0.375" (9.5mm) lead length at TA=55°C	I <sub>(AV)</sub>	1	А
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	30	А
Maximum Instantaneous Forward Voltage at 1A	$V_{F}$	1.1	V
Maximum DC Reverse Current at Rated DC T <sub>A</sub> =25°C		5	μA
Blocking Voltage T <sub>A</sub> =100°C	C I <sub>R</sub>	50	μA
Typical Junction Capacitance (Note 1)	CJ	15	pF
Typical Thermal Resistance (Note 2)	$R_{qJA}$	50	°C/W
Operating Junction and Storage Temperature Range	$T_J, T_STG$	-55 to +150	°C

#### Notes:

- 1. Measured at 1MHz and Applied Reverse Voltage of 4.0V D.C.
- 2. Thermal Resistance from Junction to Ambient at 0.375" (9.5mm) Lead Length, PCB mounted.

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#### TYPICAL CHARACTERISTICS CURVES

Fig 1: Forward Current Derating Curve

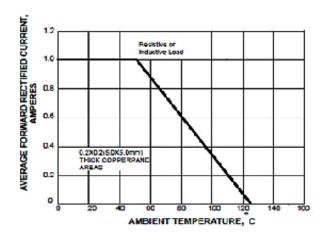
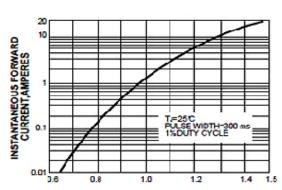


Fig 3: Typical Instantaneous Forward Characteristics



INSTANTANEOUS FORWARD VOLEAGE, VOLTS

Fig 5: Typical Junction Capacitance

100 T<sub>J</sub> 25 T T<sub></sub>

Fig 2: Maximum Non-Repetitive Peak Forward Surge Current

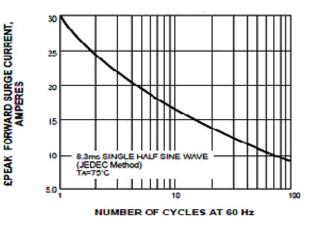


Fig 4: Typical Reverse Characteristics

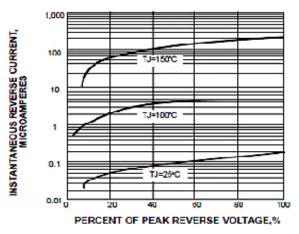
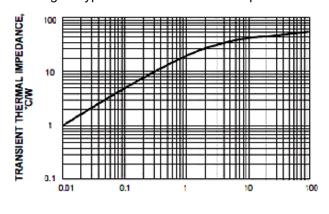


Fig 6: Typical Transient Thermal Impedance



t,PULSE DURATION,sec.

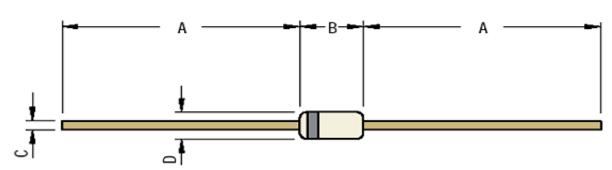
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## **PACKAGE DETAILS**

## A-405 Axial Leaded Plastic Package



## A405(26mm) Package

71100\=011111/ 1 diottago			
Α	14.60		
В	4.10	5.20	
С	0.55	0.65	
D	2.30	2.70	

All Dimensions are in mm







# Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

#### **Shelf Life of CDIL Products**

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

#### Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level			
Level	Time	Condition	
1	Unlimited	≤30 °C / 85% RH	
2	1 Year	≤30 °C / 60% RH	
2a	4 Weeks	≤30 °C / 60% RH	
3	168 Hours	≤30 °C / 60% RH	
4	72 Hours	≤30 °C / 60% RH	
5	48 Hours	≤30 °C / 60% RH	
5а	24 Hours	≤30 °C / 60% RH	
6	Time on Label(TOL)	≤30 °C / 60% RH	

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#### **Customer Notes**

#### **Component Disposal Instructions**

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

#### **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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